DATA SHEET

SENKO[®] Advanced Components In collaboration with **molex** & **3M**

MPO EBO EZ-WAY CONNECTOR Expanded Beam Optics

MPO EBO EZ-Way Connector

SENKO's MPO EBO EZ-WAY[™] connector is designed for next-generation data centers, telecom networks, and harshenvironment applications, offering a cutting-edge solution for high-speed optical interconnects. This next gen design incorporates the SENKO EZ-WAY[™] push-pull Boot feature for high density applications coupled with the noncontact, lensed 3M[™] Expanded Beam Optical Ferrule, allowing it to be deployed in environments not always suited to the traditional physical contact products. The non-contact ferrule ensures it is more resistant to dirt, debris, and damage from vibration, thus ensuring stable and reliable connections over time for optimal network performance. It is also compatible with standard MPO Adapters and the SENKO 776 series of MPO SC Footprint adapters, making it suitable for use in legacy applications and panel designs.

Push-pull boot for dense patch panels

FEATURES

- SENKO's push-pull boot suitable for high density applications
- Resistant to dirt, debris, and vibration damage
- Compatible with standard MPO Adapters and SENKO 776 series of MPO SC Footprint adapters
- Designed in collaboration with Molex for interoperability and intermateability
- Non-contact, lensed 3M[™] Expanded Beam Optical Ferrule

Integrating **3M** revolutionary EBO ferrule technology

Dust

Insensitivity

Fits Standard MPO Adapters

Specifications

	Singlemode	Multimode
Durability	1000 mating cycles	
Typical Insertion Loss (dB)*	<0.70	<0.70
Typical Return Loss (dB)*	≥55	≥25
Operating Temperature	-10°C to +60°C	

* Based on master grade jumper to low loss random mating test

APPLICATIONS

- Telecommunications
- Next-generation data centers
- Harsh environments
- Industrial applications

KEY BENEFITS

- Easy Installation and extraction
- ✓ Dust insensitivity
- ✓ Fits standard MPO adapters